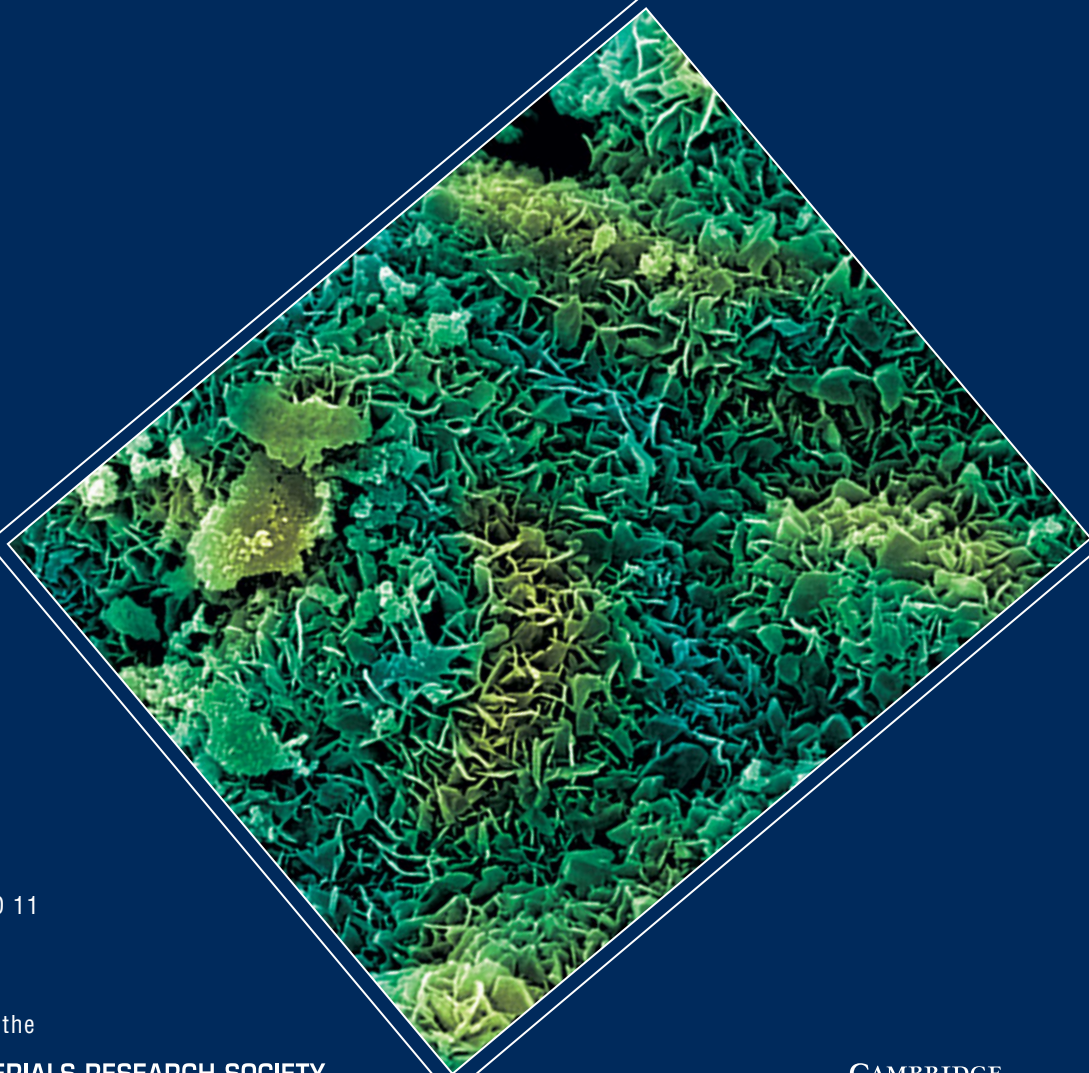




Journal of MATERIALS RESEARCH



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Journal of MATERIALS RESEARCH

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Cover: FESEM image of porous $\text{Li}_{1.2}\text{Ni}_{0.13}\text{Co}_{0.13}\text{Mn}_{0.54}\text{O}_2$. [Y. Jiang, H. Zhuang, Q. Ma, Z. Jiao, H. Zhang, R. Liu, Y. Chu, and B. Zhao: Synthesis of porous Li_2MnO_3 - $\text{LiNi}_{1/3}\text{Co}_{1/3}\text{Mn}_{1/3}\text{O}_2$ nanoplates via colloidal crystal template. p. 1505].

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